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Details

Product Status	Not For New Designs
Core Processor	8051
Core Size	8-Bit
Speed	48MHz
Connectivity	SMBus (2-Wire/I ² C), SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	25
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 17x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f34b-gqr

C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D

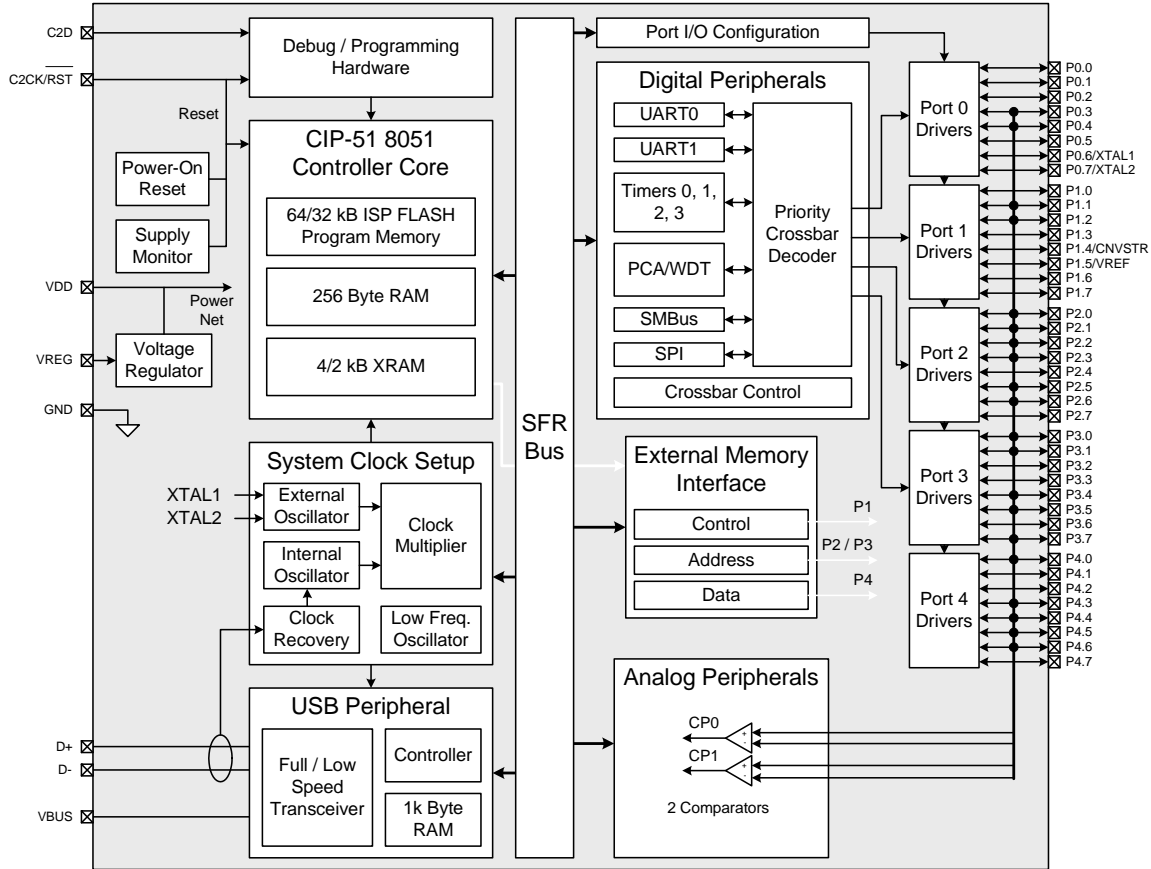


Figure 1.3. C8051F348/C Block Diagram

C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D

Table 5.1. ADC0 Electrical Characteristics

$V_{DD} = 3.0\text{ V}$, $V_{REF} = 2.40\text{ V}$, -40 to $+85\text{ }^{\circ}\text{C}$ unless otherwise specified

Parameter	Conditions	Min	Typ	Max	Units
DC Accuracy					
Resolution		10			bits
Integral Nonlinearity			± 0.5	± 1	LSB
Differential Nonlinearity	Guaranteed Monotonic		± 0.5	± 1	LSB
Offset Error		-15	0	+15	LSB
Full Scale Error		-15	-1	+15	LSB
Offset Temperature Coefficient			10		ppm/ $^{\circ}\text{C}$
Dynamic Performance (10 kHz sine-wave Single-ended input, 1 dB below Full Scale, 200 ksp/s)					
Signal-to-Noise Plus Distortion		51	52.5		dB
Total Harmonic Distortion	Up to the 5 th harmonic		-67		dB
Spurious-Free Dynamic Range			78		dB
Conversion Rate					
SAR Conversion Clock				3	MHz
Conversion Time in SAR Clocks		10			clocks
Track/Hold Acquisition Time		300			ns
Throughput Rate				200	ksp/s
Analog Inputs					
ADC Input Voltage Range	Single Ended (AIN+ – GND) Differential (AIN+ – AIN-)	0 -VREF		VREF VREF	V V
Absolute Pin Voltage with respect to GND	Single Ended or Differential	0		V_{DD}	V
Input Capacitance			5		pF
Temperature Sensor					
Linearity ¹			± 0.1		$^{\circ}\text{C}$
Gain			2.86		mV/ $^{\circ}\text{C}$
Gain Error ²			± 33.5		$\mu\text{V}/^{\circ}\text{C}$
Offset ¹	(Temp = $0\text{ }^{\circ}\text{C}$)		776		mV
Offset Error ²			± 8.51		mV
Power Specifications					
Power Supply Current (V_{DD} supplied to ADC0)	Operating Mode, 200 ksp/s		400	900	μA
Power Supply Rejection			± 0.3		mV/V

Notes:

1. Includes ADC offset, gain, and linearity variations.
2. Represents one standard deviation from the mean.

8. Voltage Regulator (REG0)

C8051F34x devices include a voltage regulator (REG0). When enabled, the REG0 output appears on the V_{DD} pin and can be used to power external devices. REG0 can be enabled/disabled by software using bit REGEN in register REG0CN. See Table 8.1 for REG0 electrical characteristics.

Note that the VBUS signal must be connected to the VBUS pin when using the device in a USB network. The VBUS signal should only be connected to the REGIN pin when operating the device as a bus-powered function. REG0 configuration options are shown in Figure 8.1–Figure 8.4.

8.1. Regulator Mode Selection

REG0 offers a low power mode intended for use when the device is in suspend mode. In this low power mode, the REG0 output remains as specified; however the REG0 dynamic performance (response time) is degraded. See Table 8.1 for normal and low power mode supply current specifications. The REG0 mode selection is controlled via the REGMOD bit in register REG0CN.

8.2. VBUS Detection

When the USB Function Controller is used (see section **Section “16. Universal Serial Bus Controller (USB)” on page 159**), the VBUS signal should be connected to the VBUS pin. The VBSTAT bit (register REG0CN) indicates the current logic level of the VBUS signal. If enabled, a VBUS interrupt will be generated when the VBUS signal matches the polarity selected by the VBPOL bit in register REG0CN. The VBUS interrupt is level-sensitive, and has no associated interrupt pending flag. The VBUS interrupt will be active as long as the VBUS signal matches the polarity selected by VBPOL. See Table 8.1 for VBUS input parameters.

Important Note: When USB is selected as a reset source, a system reset will be generated when the VBUS signal matches the polarity selected by the VBPOL bit. See **Section “11. Reset Sources” on page 100** for details on selecting USB as a reset source

Table 8.1. Voltage Regulator Electrical Specifications

–40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Input Voltage Range ¹		2.7		5.25	V
Output Voltage (V_{DD}) ²	Output Current = 1 to 100 mA	3.0	3.3	3.6	V
Output Current ²				100	mA
VBUS Detection Input Low Voltage				1.0	V
VBUS Detection Input High Voltage		3.0			V
Bias Current	Normal Mode (REGMOD = '0') Low Power Mode (REGMOD = '1')		65 35	111 61	μA
Dropout Voltage (V_{DO}) ³			1		mV/mA

Notes:

1. Input range specified for regulation. When an external regulator is used, should be tied to V_{DD} .
2. Output current is total regulator output, including any current required by the C8051F34x.
3. The minimum input voltage is 2.70 V or $V_{DD} + V_{DO}$ (max load), whichever is greater.

C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D

9.2.6. Special Function Registers

The direct-access data memory locations from 0x80 to 0xFF constitute the special function registers (SFRs). The SFRs provide control and data exchange with the CIP-51's resources and peripherals. The CIP-51 duplicates the SFRs found in a typical 8051 implementation as well as implementing additional SFRs used to configure and access the sub-systems unique to the MCU. This allows the addition of new functionality while retaining compatibility with the MCS-51™ instruction set. Table 9.2 lists the SFRs implemented in the CIP-51 System Controller.

The SFR registers are accessed anytime the direct addressing mode is used to access memory locations from 0x80 to 0xFF. SFRs with addresses ending in 0x0 or 0x8 (e.g. P0, TCON, SCON0, IE, etc.) are bit-addressable as well as byte-addressable. All other SFRs are byte-addressable only. Unoccupied addresses in the SFR space are reserved for future use. Accessing these areas will have an indeterminate effect and should be avoided. Refer to the corresponding pages of the datasheet, as indicated in Table 9.3, for a detailed description of each register.

Table 9.2. Special Function Register (SFR) Memory Map

F8	SPI0CN	PCA0L	PCA0H	PCA0CPL0	PCA0CPH0	PCA0CPL4	PCA0CPH4	VDM0CN
F0	B	P0MDIN	P1MDIN	P2MDIN	P3MDIN	P4MDIN	EIP1	EIP2
E8	ADC0CN	PCA0CPL1	PCA0CPH1	PCA0CPL2	PCA0CPH2	PCA0CPL3	PCA0CPH3	RSTSRC
E0	ACC	XBR0	XBR1	XBR2	IT01CF	SMOD1	EIE1	EIE2
D8	PCA0CN	PCA0MD	PCA0CPM0	PCA0CPM1	PCA0CPM2	PCA0CPM3	PCA0CPM4	P3SKIP
D0	PSW	REF0CN	SCON1	SBUF1	P0SKIP	P1SKIP	P2SKIP	USB0XCEN
C8	TMR2CN	REG0CN	TMR2RLL	TMR2RLH	TMR2L	TMR2H	-	-
C0	SMB0CN	SMB0CF	SMB0DAT	ADC0GTL	ADC0GTH	ADC0LTL	ADC0LTH	P4
B8	IP	CLKMUL	AMX0N	AMX0P	ADC0CF	ADC0L	ADC0H	-
B0	P3	OSCXCEN	OSCICN	OSCICL	SBRL1	SBRLH1	FLSCL	FLKEY
A8	IE	CLKSEL	EMI0CN	-	SBCON1	-	P4MDOUT	PFE0CN
A0	P2	SPI0CFG	SPI0CKR	SPI0DAT	P0MDOUT	P1MDOUT	P2MDOUT	P3MDOUT
98	SCON0	SBUF0	CPT1CN	CPT0CN	CPT1MD	CPT0MD	CPT1MX	CPT0MX
90	P1	TMR3CN	TMR3RLL	TMR3RLH	TMR3L	TMR3H	USB0ADR	USB0DAT
88	TCON	TMOD	TL0	TL1	TH0	TH1	CKCON	PSCTL
80	P0	SP	DPL	DPH	EMI0TC	EMI0CF	OSCLCN	PCON
	0(8)	1(9)	2(A)	3(B)	4(C)	5(D)	6(E)	7(F)

(bit addressable)

Table 9.3. Special Function Registers

SFRs are listed in alphabetical order. All undefined SFR locations are reserved.

Register	Address	Description	Page
ACC	0xE0	Accumulator	87
ADC0CF	0xBC	ADC0 Configuration	50
ADC0CN	0xE8	ADC0 Control	51
ADC0GTH	0xC4	ADC0 Greater-Than Compare High	52
ADC0GTL	0xC3	ADC0 Greater-Than Compare Low	52
ADC0H	0xBE	ADC0 High	50
ADC0L	0xBD	ADC0 Low	50
ADC0LTH	0xC6	ADC0 Less-Than Compare Word High	53
ADC0LTL	0xC5	ADC0 Less-Than Compare Word Low	53
AMX0N	0xBA	AMUX0 Negative Channel Select	49
AMX0P	0xBB	AMUX0 Positive Channel Select	48
B	0xF0	B Register	88
CKCON	0x8E	Clock Control	241
CLKMUL	0xB9	Clock Multiplier	138
CLKSEL	0xA9	Clock Select	140
CPT0CN	0x9B	Comparator0 Control	62
CPT0MD	0x9D	Comparator0 Mode Selection	64
CPT0MX	0x9F	Comparator0 MUX Selection	63
CPT1CN	0x9A	Comparator1 Control	65
CPT1MD	0x9C	Comparator1 Mode Selection	67
CPT1MX	0x9E	Comparator1 MUX Selection	66
DPH	0x83	Data Pointer High	86
DPL	0x82	Data Pointer Low	86
EIE1	0xE6	Extended Interrupt Enable 1	93
EIE2	0xE7	Extended Interrupt Enable 2	95
EIP1	0xF6	Extended Interrupt Priority 1	94
EIP2	0xF7	Extended Interrupt Priority 2	95
EMIOCN	0xAA	External Memory Interface Control	117
EMIOCF	0x85	External Memory Interface Configuration	118
EMIOTC	0x84	External Memory Interface Timing	123
FLKEY	0xB7	Flash Lock and Key	112
FLSCL	0xB6	Flash Scale	113
IE	0xA8	Interrupt Enable	91
IP	0xB8	Interrupt Priority	92
IT01CF	0xE4	INT0/INT1 Configuration	96
OSCICL	0xB3	Internal Oscillator Calibration	133
OSICN	0xB2	Internal Oscillator Control	132
OSCLCN	0x86	Internal Low-Frequency Oscillator Control	134
OSXCN	0xB1	External Oscillator Control	137
P0	0x80	Port 0 Latch	150
P0MDIN	0xF1	Port 0 Input Mode Configuration	150
P0MDOUT	0xA4	Port 0 Output Mode Configuration	151
P0SKIP	0xD4	Port 0 Skip	151
P1	0x90	Port 1 Latch	152

11.3. External Reset

The external $\overline{\text{RST}}$ pin provides a means for external circuitry to force the device into a reset state. Asserting an active-low signal on the $\overline{\text{RST}}$ pin generates a reset; an external pull-up and/or decoupling of the $\overline{\text{RST}}$ pin may be necessary to avoid erroneous noise-induced resets. See Table 11.1 for complete $\overline{\text{RST}}$ pin specifications. The PINRSF flag (RSTSRC.0) is set on exit from an external reset.

11.4. Missing Clock Detector Reset

The Missing Clock Detector (MCD) is a one-shot circuit that is triggered by the system clock. If more than 100 μs pass between rising edges on the system clock, the one-shot will time out and generate a reset. After a MCD reset, the MCDRSF flag (RSTSRC.2) will read '1', signifying the MCD as the reset source; otherwise, this bit reads '0'. Writing a '1' to the MCDRSF bit enables the Missing Clock Detector; writing a '0' disables it. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

11.5. Comparator0 Reset

Comparator0 can be configured as a reset source by writing a '1' to the CORSEF flag (RSTSRC.5). Comparator0 should be enabled and allowed to settle prior to writing to CORSEF to prevent any turn-on chatter on the output from generating an unwanted reset. The Comparator0 reset is active-low: if the non-inverting input voltage (on CP0+) is less than the inverting input voltage (on CP0-), a system reset is generated. After a Comparator0 reset, the CORSEF flag (RSTSRC.5) will read '1' signifying Comparator0 as the reset source; otherwise, this bit reads '0'. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

11.6. PCA Watchdog Timer Reset

The programmable Watchdog Timer (WDT) function of the Programmable Counter Array (PCA) can be used to prevent software from running out of control during a system malfunction. The PCA WDT function can be enabled or disabled by software as described in **Section “22.3. Watchdog Timer Mode” on page 264**; the WDT is enabled and clocked by SYSCLK / 12 following any reset. If a system malfunction prevents user software from updating the WDT, a reset is generated and the WDTRSF bit (RSTSRC.5) is set to '1'. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

11.7. Flash Error Reset

If a Flash read/write/erase or program read targets an illegal address, a system reset is generated. This may occur due to any of the following:

- A Flash write or erase is attempted above user code space. This occurs when PSWE is set to “1”, and a MOVX write operation is attempted above address 0x7FFF (32 kB Flash devices) or 0xFBFF (64 kB Flash devices).
- A Flash read is attempted above user code space. This occurs when a MOVC operation is attempted above address 0x7FFF (32 kB Flash devices) or 0xFBFF (64 kB Flash devices).
- A Program read is attempted above user code space. This occurs when user code attempts to branch to an address above 0x7FFF (32 kB Flash devices) or 0xFBFF (64 kB Flash devices).
- A Flash read, write or erase attempt is restricted due to a Flash security setting (see **Section “12.3. Security Options” on page 109**).
- A Flash Write or Erase is attempted when the V_{DD} monitor is not enabled.

The FERROR bit (RSTSRC.6) is set following a Flash error reset. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

Table 11.1. Reset Electrical Characteristics

–40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
$\overline{\text{RST}}$ Output Low Voltage	$I_{OL} = 8.5 \text{ mA}$, $V_{DD} = 2.7 \text{ to } 3.6 \text{ V}$			0.6	V
$\overline{\text{RST}}$ Input High Voltage		$0.7 \times V_{DD}$			V
$\overline{\text{RST}}$ Input Low Voltage				$0.3 \times V_{DD}$	
$\overline{\text{RST}}$ Input Pull-Up Current	$\overline{\text{RST}} = 0.0 \text{ V}$		25	40	μA
V_{DD} POR Threshold (V_{RST})		2.40	2.55	2.70	V
Missing Clock Detector Timeout	Time from last system clock rising edge to reset initiation	100	220	500	μs
Reset Time Delay	Delay between release of any reset source and code execution at location 0x0000	5.0			μs
Minimum $\overline{\text{RST}}$ Low Time to Generate a System Reset		15			μs
V_{DD} Monitor Turn-on Time		100			μs
V_{DD} Monitor Supply Current			20	50	μA

14.4. 4x Clock Multiplier

The 4x Clock Multiplier allows a 12 MHz oscillator to generate the 48 MHz clock required for Full Speed USB communication (see **Section “16.4. USB Clock Configuration” on page 166**). A divided version of the Multiplier output can also be used as the system clock. C8051F340/1/2/3 devices can use the 48 MHz Clock Multiplier output as system clock. See Table 3.1, “Global DC Electrical Characteristics,” on page 25 for system clock frequency specifications. See **Section 14.5** for details on system clock and USB clock source selection.

The 4x Clock Multiplier is configured via the CLKMUL register. The procedure for configuring and enabling the 4x Clock Multiplier is as follows:

1. Reset the Multiplier by writing 0x00 to register CLKMUL.
2. Select the Multiplier input source via the MULSEL bits.
3. Enable the Multiplier with the MULEN bit (CLKMUL | = 0x80).
4. Delay for >5 μ s.
5. Initialize the Multiplier with the MULINIT bit (CLKMUL | = 0xC0).
6. Poll for MULRDY => ‘1’.

Important Note: When using an external oscillator as the input to the 4x Clock Multiplier, the external source must be enabled and stable before the Multiplier is initialized. See **Section 14.5** for details on selecting an external oscillator source.

SFR Definition 14.5. CLKMUL: Clock Multiplier Control

R/W	R/W	R	R/W	R/W	R/W	R/W	R/W	Reset Value
MULEN	MULINIT	MULRDY	-	-	-	MULSEL		00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address 0xB9

Bit7: MULEN: Clock Multiplier Enable
0: Clock Multiplier disabled.
1: Clock Multiplier enabled.

Bit6: MULINIT: Clock Multiplier Initialize
This bit should be a ‘0’ when the Clock Multiplier is enabled. Once enabled, writing a ‘1’ to this bit will initialize the Clock Multiplier. The MULRDY bit reads ‘1’ when the Clock Multiplier is stabilized.

Bit5: MULRDY: Clock Multiplier Ready
This read-only bit indicates the status of the Clock Multiplier.
0: Clock Multiplier not ready.
1: Clock Multiplier ready (locked).

Bits4–2: Unused. Read = 000b; Write = don’t care.

Bits1–0: MULSEL: Clock Multiplier Input Select
These bits select the clock supplied to the Clock Multiplier.

MULSEL	Selected Clock
00	Internal Oscillator
01	External Oscillator
10	External Oscillator / 2
11	RESERVED

C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D

SFR Definition 15.1. XBR0: Port I/O Crossbar Register 0

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
CP1AE	CP1E	CP0AE	CP0E	SYSCKE	SMB0E	SPI0E	URT0E	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xE1
<p>Bit7: CP1AE: Comparator1 Asynchronous Output Enable 0: Asynchronous CP1 unavailable at Port pin. 1: Asynchronous CP1 routed to Port pin.</p> <p>Bit6: CP1E: Comparator1 Output Enable 0: CP1 unavailable at Port pin. 1: CP1 routed to Port pin.</p> <p>Bit5: CP0AE: Comparator0 Asynchronous Output Enable 0: Asynchronous CP0 unavailable at Port pin. 1: Asynchronous CP0 routed to Port pin.</p> <p>Bit4: CP0E: Comparator0 Output Enable 0: CP0 unavailable at Port pin. 1: CP0 routed to Port pin.</p> <p>Bit3: SYSCKE: /SYSCLK Output Enable 0: /SYSCLK unavailable at Port pin. 1: /SYSCLK output routed to Port pin.</p> <p>Bit2: SMB0E: SMBus I/O Enable 0: SMBus I/O unavailable at Port pins. 1: SMBus I/O routed to Port pins.</p> <p>Bit1: SPI0E: SPI I/O Enable 0: SPI I/O unavailable at Port pins. 1: SPI I/O routed to Port pins.</p> <p>Bit0: URT0E: UART0 I/O Output Enable 0: UART0 I/O unavailable at Port pins. 1: UART0 TX0, RX0 routed to Port pins P0.4 and P0.5.</p>								

C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D

Table 15.1. Port I/O DC Electrical Characteristics

$V_{DD} = 2.7$ to 3.6 V, -40 to $+85$ °C unless otherwise specified

Parameters	Conditions	Min	Typ	Max	Units
Output High Voltage	$I_{OH} = -3$ mA, Port I/O push-pull $I_{OH} = -10$ μ A, Port I/O push-pull $I_{OH} = -10$ mA, Port I/O push-pull	$V_{DD} - 0.7$ $V_{DD} - 0.1$	$V_{DD} - 0.8$		V
Output Low Voltage	$I_{OL} = 8.5$ mA $I_{OL} = 10$ μ A $I_{OL} = 25$ mA		1.0	0.6 0.1	V
Input High Voltage		2.0			V
Input Low Voltage				0.8	V
Input Leakage Current	Weak Pull-up Off Weak Pull-up On, $V_{IN} = 0$ V		25	± 1 50	μ A

SFR Definition 16.1. USB0XCN: USB0 Transceiver Control

R/W	R/W	R/W	R/W	R/W	R	R	R	Reset Value
PREN	PHYEN	SPEED	PHYTST1	PHYTST0	DFREC	Dp	Dn	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xD7

Bit7: PREN: Internal Pull-up Resistor Enable
The location of the pull-up resistor (D+ or D–) is determined by the SPEED bit.
0: Internal pull-up resistor disabled (device effectively detached from the USB network).
1: Internal pull-up resistor enabled when VBUS is present (device attached to the USB network).

Bit6: PHYEN: Physical Layer Enable
This bit enables/disables the USB0 physical layer transceiver.
0: Transceiver disabled (suspend).
1: Transceiver enabled (normal).

Bit5: SPEED: USB0 Speed Select
This bit selects the USB0 speed.
0: USB0 operates as a Low Speed device. If enabled, the internal pull-up resistor appears on the D– line.
1: USB0 operates as a Full Speed device. If enabled, the internal pull-up resistor appears on the D+ line.

Bits4–3: PHYTST1–0: Physical Layer Test
These bits can be used to test the USB0 transceiver.

PHYTST[1:0]	Mode	D+	D–
00b	Mode 0: Normal (non-test mode)	X	X
01b	Mode 1: Differential '1' Forced	1	0
10b	Mode 2: Differential '0' Forced	0	1
11b	Mode 3: Single-Ended '0' Forced	0	0

Bit2: DFREC: Differential Receiver
The state of this bit indicates the current differential value present on the D+ and D– lines when PHYEN = '1'.
0: Differential '0' signaling on the bus.
1: Differential '1' signaling on the bus.

Bit1: Dp: D+ Signal Status
This bit indicates the current logic level of the D+ pin.
0: D+ signal currently at logic 0.
1: D+ signal currently at logic 1.

Bit0: Dn: D- Signal Status
This bit indicates the current logic level of the D– pin.
0: D– signal currently at logic 0.
1: D– signal currently at logic 1.

16.3. USB Register Access

The USB0 controller registers listed in Table 16.2 are accessed through two SFRs: USB0 Address (USB0ADR) and USB0 Data (USB0DAT). The USB0ADR register selects which USB register is targeted

USB Register Definition 16.14. IN1IE: USB0 IN Endpoint Interrupt Enable

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	-	IN3E	IN2E	IN1E	EP0E	00001111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	USB Address: 0x07

Bits7–4: Unused. Read = 0000b. Write = don't care.
 Bit3: IN3E: IN Endpoint 3 Interrupt Enable
 0: IN Endpoint 3 interrupt disabled.
 1: IN Endpoint 3 interrupt enabled.
 Bit2: IN2E: IN Endpoint 2 Interrupt Enable
 0: IN Endpoint 2 interrupt disabled.
 1: IN Endpoint 2 interrupt enabled.
 Bit1: IN1E: IN Endpoint 1 Interrupt Enable
 0: IN Endpoint 1 interrupt disabled.
 1: IN Endpoint 1 interrupt enabled.
 Bit0: EP0E: Endpoint 0 Interrupt Enable
 0: Endpoint 0 interrupt disabled.
 1: Endpoint 0 interrupt enabled.

USB Register Definition 16.15. OUT1IE: USB0 Out Endpoint Interrupt Enable

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	-	OUT3E	OUT2E	OUT1E	-	00001110
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	USB Address: 0x09

Bits7–4: Unused. Read = 0000b. Write = don't care.
 Bit3: OUT3E: OUT Endpoint 3 Interrupt Enable
 0: OUT Endpoint 3 interrupt disabled.
 1: OUT Endpoint 3 interrupt enabled.
 Bit2: OUT2E: OUT Endpoint 2 Interrupt Enable
 0: OUT Endpoint 2 interrupt disabled.
 1: OUT Endpoint 2 interrupt enabled.
 Bit1: OUT1E: OUT Endpoint 1 Interrupt Enable
 0: OUT Endpoint 1 interrupt disabled.
 1: OUT Endpoint 1 interrupt enabled.
 Bit0: Unused. Read = 0; Write = don't care.

17.1. Supporting Documents

It is assumed the reader is familiar with or has access to the following supporting documents:

1. The I2C-Bus and How to Use It (including specifications), Philips Semiconductor.
2. The I2C-Bus Specification -- Version 2.0, Philips Semiconductor.
3. System Management Bus Specification -- Version 1.1, SBS Implementers Forum.

17.2. SMBus Configuration

Figure 17.2 shows a typical SMBus configuration. The SMBus specification allows any recessive voltage between 3.0 V and 5.0 V; different devices on the bus may operate at different voltage levels. The bi-directional SCL (serial clock) and SDA (serial data) lines must be connected to a positive power supply voltage through a pull-up resistor or similar circuit. Every device connected to the bus must have an open-drain or open-collector output for both the SCL and SDA lines, so that both are pulled high (recessive state) when the bus is free. The maximum number of devices on the bus is limited only by the requirement that the rise and fall times on the bus not exceed 300 ns and 1000 ns, respectively.

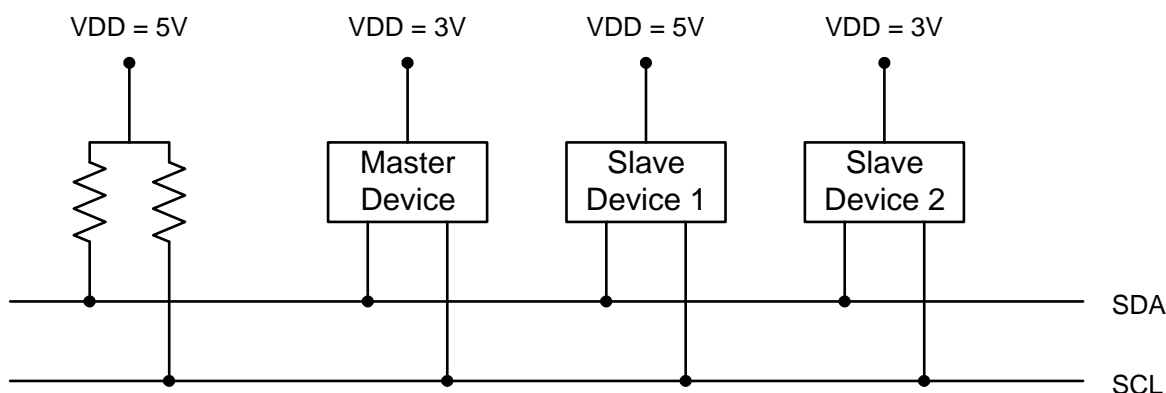


Figure 17.2. Typical SMBus Configuration

17.3. SMBus Operation

Two types of data transfers are possible: data transfers from a master transmitter to an addressed slave receiver (WRITE), and data transfers from an addressed slave transmitter to a master receiver (READ). The master device initiates both types of data transfers and provides the serial clock pulses on SCL. The SMBus interface may operate as a master or a slave, and multiple master devices on the same bus are supported. If two or more masters attempt to initiate a data transfer simultaneously, an arbitration scheme is employed with a single master always winning the arbitration. Note that it is not necessary to specify one device as the Master in a system; any device who transmits a START and a slave address becomes the master for the duration of that transfer.

A typical SMBus transaction consists of a START condition followed by an address byte (Bits7-1: 7-bit slave address; Bit0: R/W direction bit), one or more bytes of data, and a STOP condition. Each byte that is received (by a master or slave) must be acknowledged (ACK) with a low SDA during a high SCL (see Figure 17.3). If the receiving device does not ACK, the transmitting device will read a NACK (not acknowledge), which is a high SDA during a high SCL.

17.4.3. Data Register

The SMBus Data register SMB0DAT holds a byte of serial data to be transmitted or one that has just been received. Software may safely read or write to the data register when the SI flag is set. Software should not attempt to access the SMB0DAT register when the SMBus is enabled and the SI flag is cleared to logic 0, as the interface may be in the process of shifting a byte of data into or out of the register.

Data in SMB0DAT is always shifted out MSB first. After a byte has been received, the first bit of received data is located at the MSB of SMB0DAT. While data is being shifted out, data on the bus is simultaneously being shifted in. SMB0DAT always contains the last data byte present on the bus. In the event of lost arbitration, the transition from master transmitter to slave receiver is made with the correct data or address in SMB0DAT.

SFR Definition 17.3. SMB0DAT: SMBus Data

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xC2

Bits7-0: SMB0DAT: SMBus Data.
 The SMB0DAT register contains a byte of data to be transmitted on the SMBus serial interface or a byte that has just been received on the SMBus serial interface. The CPU can read from or write to this register whenever the SI serial interrupt flag (SMB0CN.0) is set to logic 1. The serial data in the register remains stable as long as the SI flag is set. When the SI flag is not set, the system may be in the process of shifting data in/out and the CPU should not attempt to access this register.

17.5. SMBus Transfer Modes

The SMBus interface may be configured to operate as master and/or slave. At any particular time, it will be operating in one of the following four modes: Master Transmitter, Master Receiver, Slave Transmitter, or Slave Receiver. The SMBus interface enters Master Mode any time a START is generated, and remains in Master Mode until it loses an arbitration or generates a STOP. An SMBus interrupt is generated at the end of all SMBus byte frames; however, note that the interrupt is generated before the ACK cycle when operating as a receiver, and after the ACK cycle when operating as a transmitter.

17.5.1. Master Transmitter Mode

Serial data is transmitted on SDA while the serial clock is output on SCL. The SMBus interface generates the START condition and transmits the first byte containing the address of the target slave and the data direction bit. In this case the data direction bit (R/W) will be logic 0 (WRITE). The master then transmits one or more bytes of serial data. After each byte is transmitted, an acknowledge bit is generated by the slave. The transfer is ended when the STO bit is set and a STOP is generated. Note that the interface will switch to Master Receiver Mode if SMB0DAT is not written following a Master Transmitter interrupt. Figure 17.5 shows a typical Master Transmitter sequence. Two transmit data bytes are shown, though any number of bytes may be transmitted. Notice that the 'data byte transferred' interrupts occur **after** the ACK cycle in this mode.

C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D

19.1. Baud Rate Generator

The UART1 baud rate is generated by a dedicated 16-bit timer which runs from the controller's core clock (SYSCLK), and has prescaler options of 1, 4, 12, or 48. The timer and prescaler options combined allow for a wide selection of baud rates over many SYSCLK frequencies.

The baud rate generator is configured using three registers: SBCON1, SBRLH1, and SBRL1. The UART1 Baud Rate Generator Control Register (SBCON1, SFR Definition 19.4) enables or disables the baud rate generator, and selects the prescaler value for the timer. The baud rate generator must be enabled for UART1 to function. Registers SBRLH1 and SBRL1 contain a 16-bit reload value for the dedicated 16-bit timer. The internal timer counts up from the reload value on every clock tick. On timer overflows (0xFFFF to 0x0000), the timer is reloaded. For reliable UART operation, it is recommended that the UART baud rate is not configured for baud rates faster than SYSCLK/16. The baud rate for UART1 is defined in Equation 19.1.

$$\text{Baud Rate} = \frac{\text{SYSCLK}}{(65536 - (\text{SBRLH1}:\text{SBRL1}))} \times \frac{1}{2} \times \frac{1}{\text{Prescaler}}$$

Equation 19.1. UART1 Baud Rate

A quick reference for typical baud rates and system clock frequencies is given in Table 19.1.

Table 19.1. Baud Rate Generator Settings for Standard Baud Rates

	Target Baud Rate (bps)	Actual Baud Rate (bps)	Baud Rate Error	Oscillator Divide Factor	SB1PS[1:0] (Prescaler Bits)	Reload Value in SBRLH1:SBRL1
SYSCLK = 12 MHz	230400	230769	0.16%	52	11	0xFFE6
	115200	115385	0.16%	104	11	0xFFCC
	57600	57692	0.16%	208	11	0xFF98
	28800	28846	0.16%	416	11	0xFF30
	14400	14388	0.08%	834	11	0xFE5F
	9600	9600	0.0%	1250	11	0xFD8F
	2400	2400	0.0%	5000	11	0xF63C
	1200	1200	0.0%	10000	11	0xEC78
SYSCLK = 24 MHz	230400	230769	0.16%	104	11	0xFFCC
	115200	115385	0.16%	208	11	0xFF98
	57600	57692	0.16%	416	11	0xFF30
	28800	28777	0.08%	834	11	0xFE5F
	14400	14406	0.04%	1666	11	0xFCBF
	9600	9600	0.0%	2500	11	0xFB1E
	2400	2400	0.0%	10000	11	0xEC78
	1200	1200	0.0%	20000	11	0xD8F0
SYSCLK = 48 MHz	230400	230769	0.16%	208	11	0xFF98
	115200	115385	0.16%	416	11	0xFF30
	57600	57554	0.08%	834	11	0xFE5F
	28800	28812	0.04%	1666	11	0xFCBF
	14400	14397	0.02%	3334	11	0xF97D
	9600	9600	0.0%	5000	11	0xF63C
	2400	2400	0.0%	20000	11	0xD8F0
	1200	1200	0.0%	40000	11	0xB1E0

SFR Definition 19.2. SMOD1: UART1 Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
MCE1	S1PT1	S1PT0	PE1	S1DL1	S1DL0	XBE1	SBL1	00001100
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xE5

Bit7: MCE1: Multiprocessor Communication Enable.
 0: RI will be activated if stop bit(s) are '1'.
 1: RI will be activated if stop bit(s) and extra bit are '1' (extra bit must be enabled using XBE1).
 Note: This function is not available when hardware parity is enabled.

Bits6–5: S1PT[1:0]: Parity Type.
 00: Odd
 01: Even
 10: Mark
 11: Space

Bit4: PE1: Parity Enable.
 This bit activates hardware parity generation and checking. The parity type is selected by bits S1PT1-0 when parity is enabled.
 0: Hardware parity is disabled.
 1: Hardware parity is enabled.

Bits3–2: S1DL[1:0]: Data Length.
 00: 5-bit data
 01: 6-bit data
 10: 7-bit data
 11: 8-bit data

Bit1: XBE1: Extra Bit Enable
 When enabled, the value of TBX1 will be appended to the data field.
 0: Extra Bit Disabled.
 1: Extra Bit Enabled.

Bit0: SBL1: Stop Bit Length
 0: Short - Stop bit is active for one bit time.
 1: Long - Stop bit is active for two bit times (data length = 6, 7, or 8 bits), or 1.5 bit times (data length = 5 bits).

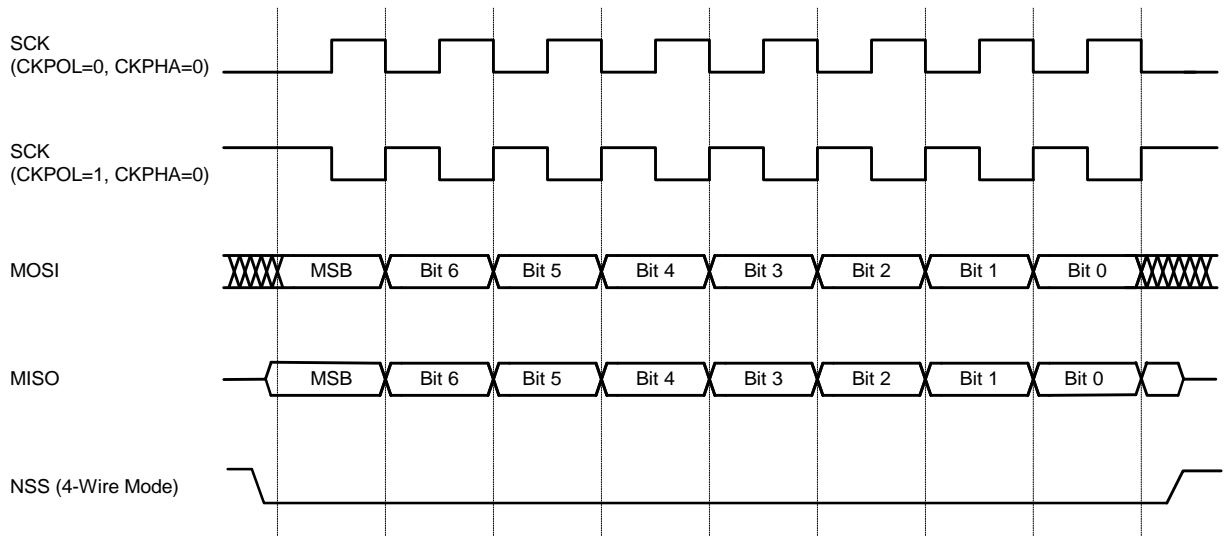


Figure 20.6. Slave Mode Data/Clock Timing (CKPHA = 0)

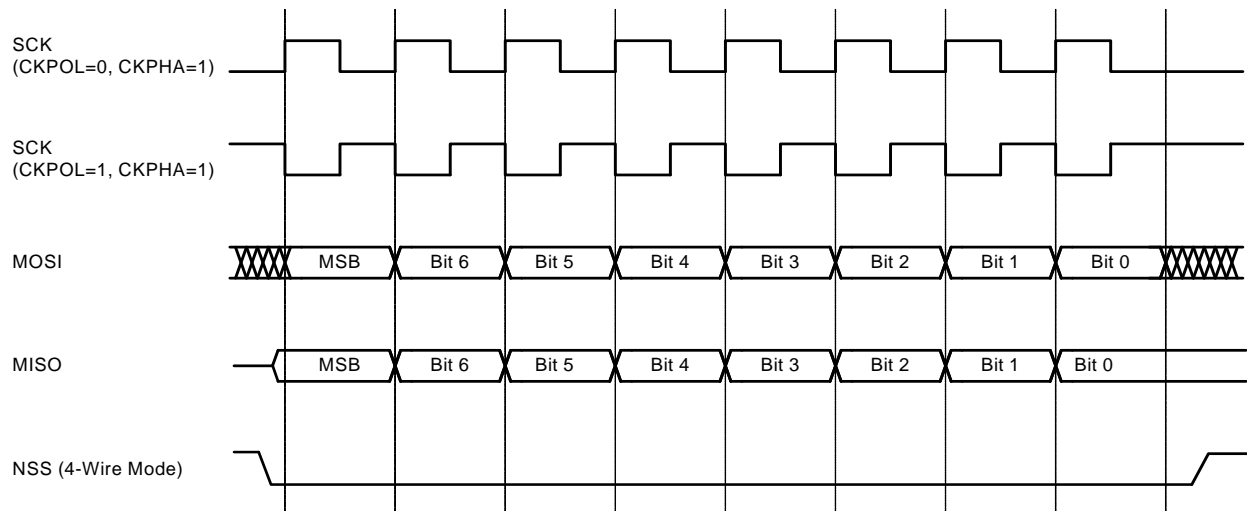


Figure 20.7. Slave Mode Data/Clock Timing (CKPHA = 1)

21.2.2. 8-bit Timers with Auto-Reload

When T2SPLIT = '1' and T2CE = '0', Timer 2 operates as two 8-bit timers (TMR2H and TMR2L). Both 8-bit timers operate in auto-reload mode as shown in Figure 21.5. TMR2RLL holds the reload value for TMR2L; TMR2RLH holds the reload value for TMR2H. The TR2 bit in TMR2CN handles the run control for TMR2H. TMR2L is always running when configured for 8-bit Mode.

Each 8-bit timer may be configured to use SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. The Timer 2 Clock Select bits (T2MH and T2ML in CKCON) select either SYSCLK or the clock defined by the Timer 2 External Clock Select bit (T2XCLK in TMR2CN), as follows:

T2MH	T2XCLK	TMR2H Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	X	SYSCLK

T2ML	T2XCLK	TMR2L Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	X	SYSCLK

The TF2H bit is set when TMR2H overflows from 0xFF to 0x00; the TF2L bit is set when TMR2L overflows from 0xFF to 0x00. When Timer 2 interrupts are enabled, an interrupt is generated each time TMR2H overflows. If Timer 2 interrupts are enabled and TF2LEN (TMR2CN.5) is set, an interrupt is generated each time either TMR2L or TMR2H overflows. When TF2LEN is enabled, software must check the TF2H and TF2L flags to determine the source of the Timer 2 interrupt. The TF2H and TF2L interrupt flags are not cleared by hardware and must be manually cleared by software.

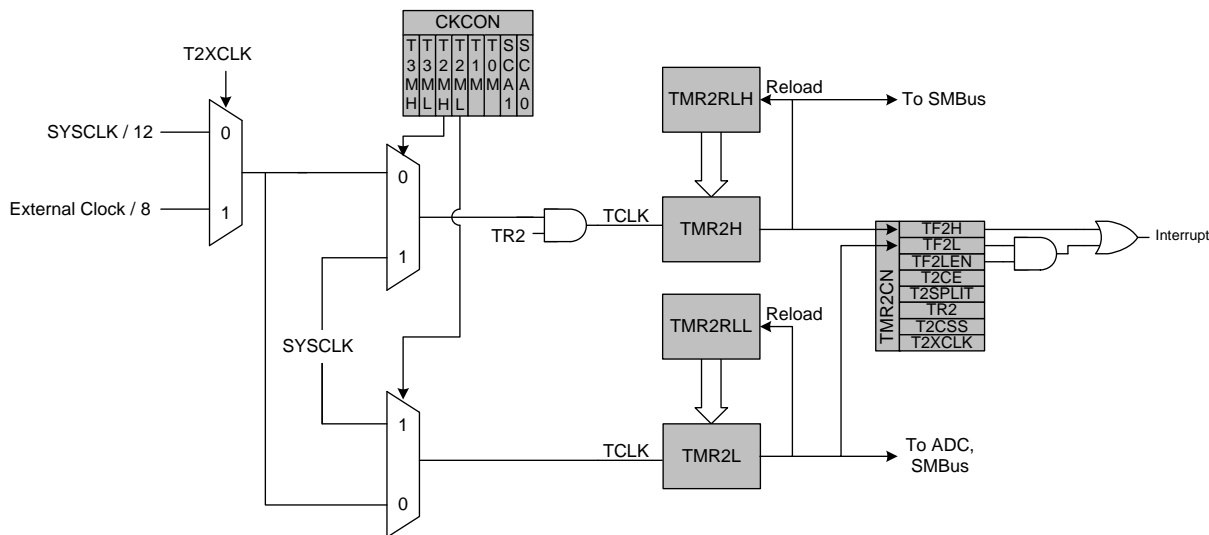


Figure 21.5. Timer 2 8-Bit Mode Block Diagram

22.2.5. 8-Bit Pulse Width Modulator Mode

Each module can be used independently to generate a pulse width modulated (PWM) output on its associated CEXn pin. The frequency of the output is dependent on the timebase for the PCA counter/timer. The duty cycle of the PWM output signal is varied using the module's PCA0CPLn capture/compare register. When the value in the low byte of the PCA counter/timer (PCA0L) is equal to the value in PCA0CPLn, the output on the CEXn pin will be set. When the count value in PCA0L overflows, the CEXn output will be reset (see Figure 22.8). Also, when the counter/timer low byte (PCA0L) overflows from 0xFF to 0x00, PCA0CPLn is reloaded automatically with the value stored in the module's capture/compare high byte (PCA0CPHn) without software intervention. Setting the ECOMn and PWMn bits in the PCA0CPMn register enables 8-Bit Pulse Width Modulator mode. The duty cycle for 8-Bit PWM Mode is given by Equation 22.2.

Important Note About Capture/Compare Registers: When writing a 16-bit value to the PCA0 Capture/Compare registers, the low byte should always be written first. Writing to PCA0CPLn clears the ECOMn bit to '0'; writing to PCA0CPHn sets ECOMn to '1'.

$$DutyCycle = \frac{(256 - PCA0CPHn)}{256}$$

Equation 22.2. 8-Bit PWM Duty Cycle

Using Equation 22.2, the largest duty cycle is 100% (PCA0CPHn = 0), and the smallest duty cycle is 0.39% (PCA0CPHn = 0xFF). A 0% duty cycle may be generated by clearing the ECOMn bit to '0'.

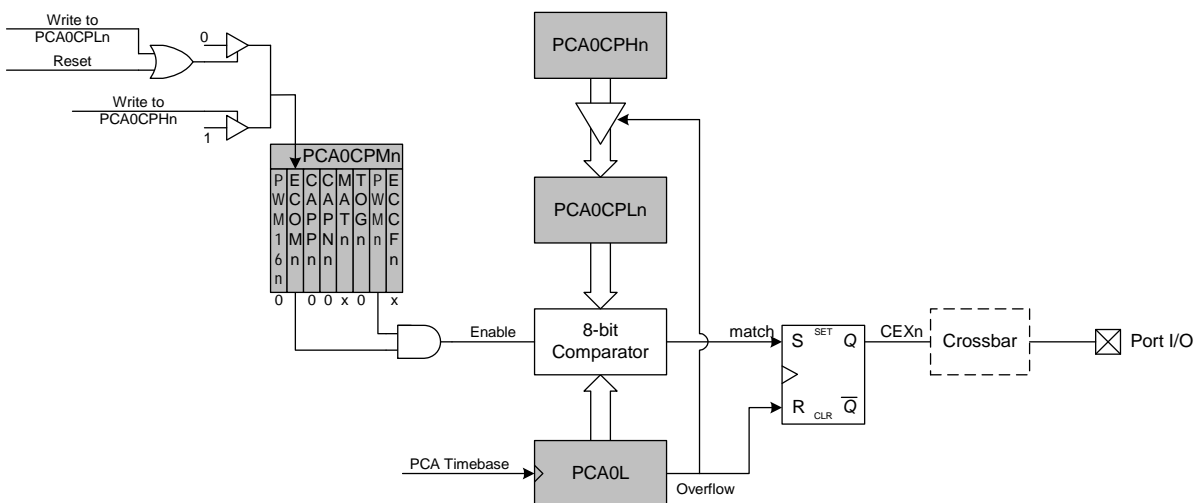


Figure 22.8. PCA 8-Bit PWM Mode Diagram